

# TC74VHC9595FT, TC74VHC9595FK

## 8-Bit Shift Register/Latch

The TC74VHC9595 is an advanced high speed 8-BIT SHIFT REGISTER/LATCH fabricated with silicon gate C<sup>2</sup>MOS technology.

TC74VHC9595 combines low power consumption of CMOS with Schottky TTL speeds.

Shift operation is accomplished on the positive going transition of the SCK input. The output register is loaded with the contents of the shift register on the positive going transition of the RCK input. Since RCK and SCK signal are independent, parallel outputs can be held stable during the shift operation.

This register can be used in serial-to-parallel conversion, data receivers, etc.

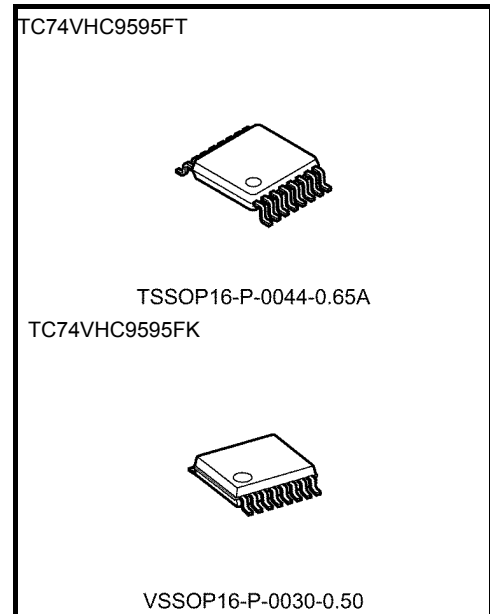
All the inputs have hysteresis between the positive-going and negative-going thresholds. Thus the TC74VHC9595 is capable of squaring up transitions of slowly changing input signals and provides an improved noise immunity.

Additionally, all the inputs have a newly developed protection circuit without a diode returned to VCC. This enables the inputs to be tolerant of up to 5.5 volts even when power supply is down. The input power-down protection capability makes the TC74VHC9595 ideal for a wide range of applications, such as interfacing between different voltages, voltage translation from 5 V to 3 V and battery back-up circuits.

A variant of the TC 74HC/VHC/AHC/LV595, the TC74VHC9595 contains negative-edge-triggered flip-flops to improve timing margins that are affected by long wires or slowly changing clocks when multiple parts are cascaded together.

### Features

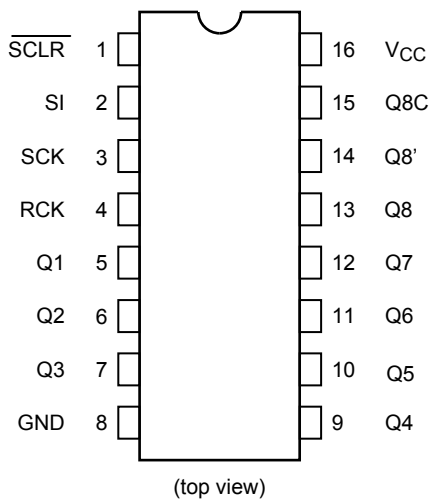
- High speed:  $f_{max} = 224\text{MHz}$  (typ.) at  $V_{CC} = 5\text{V}$
- Low power dissipation:  $I_{CC} = 4\ \mu\text{A}$  (max) at  $T_a = 25^\circ\text{C}$
- Power down protection is provided on all inputs.
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range:  $V_{CC}(\text{opr}) = 2\text{V}$  to  $5.5\text{V}$



#### Weight

TSSOP16-P-0044-0.65A	: 0.06 g (typ.)
VSSOP16-P-0030-0.50	: 0.02 g (typ.)

## Pin Assignment

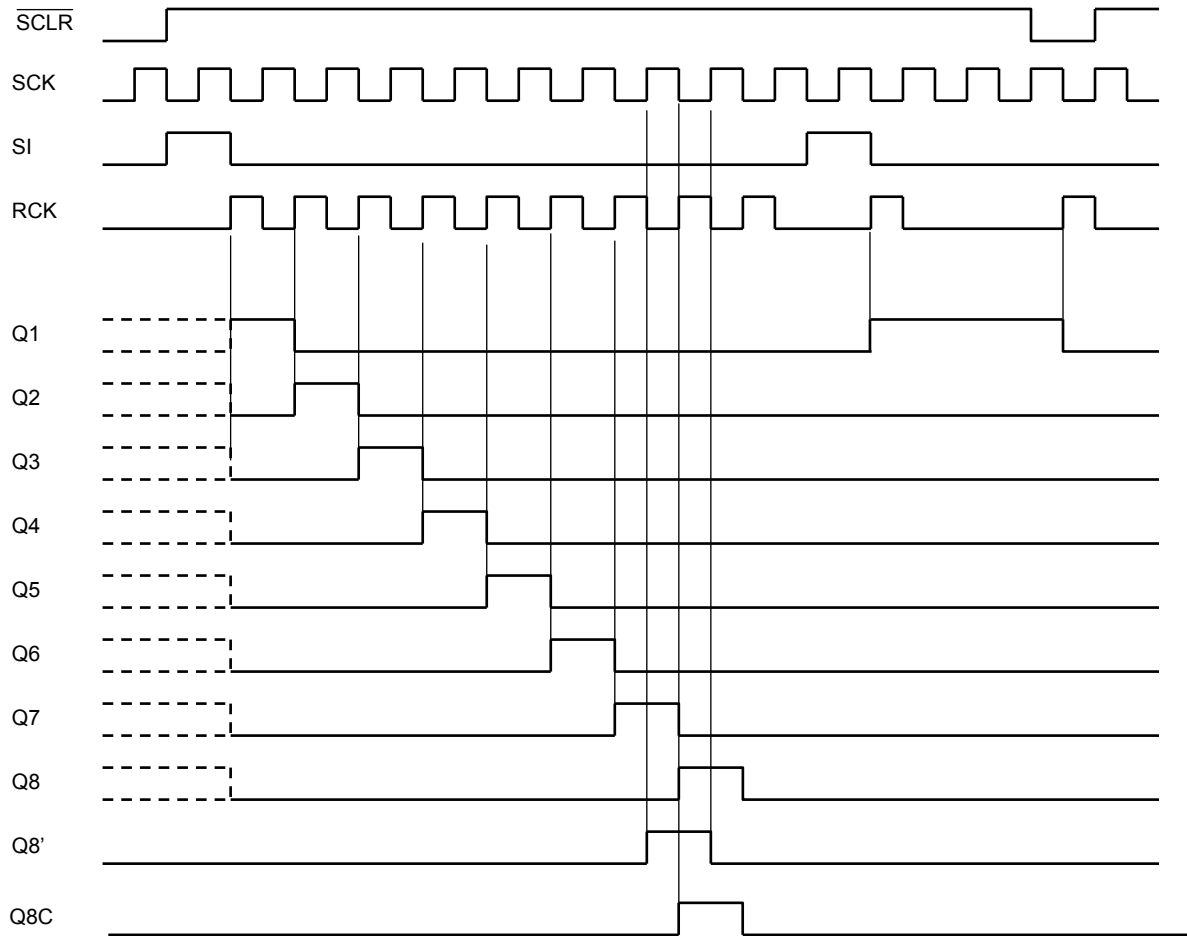


## Truth Table

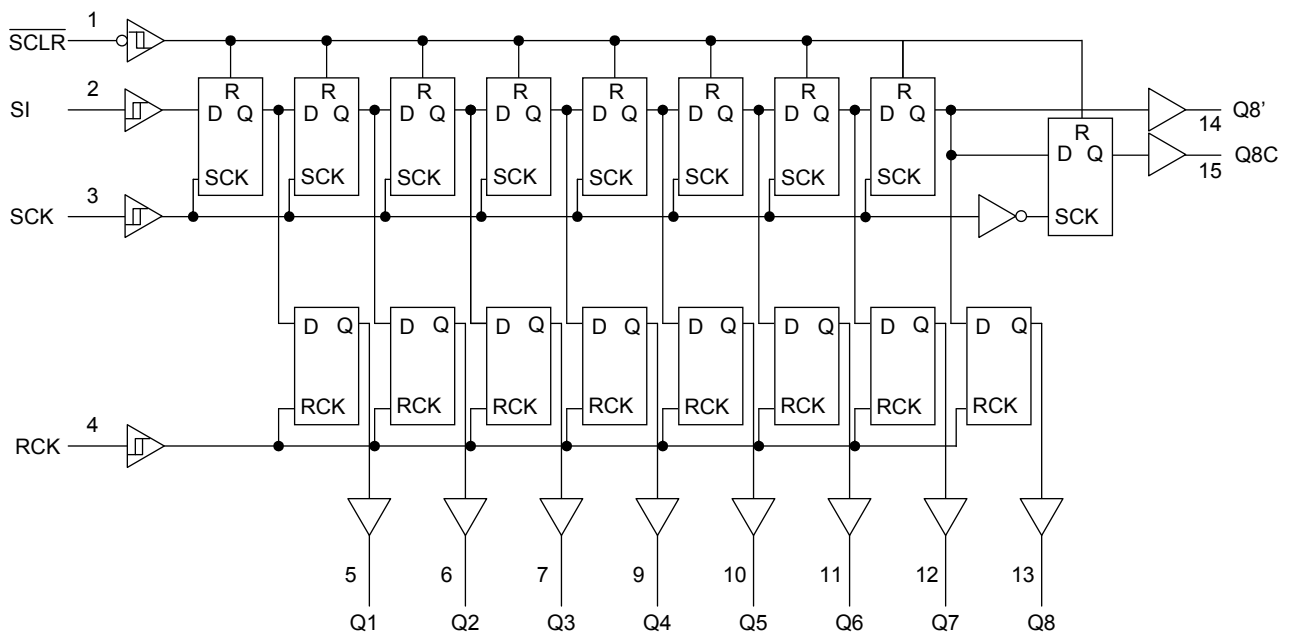
Inputs				Function
$\overline{\text{SCLR}}$	SI	SCK	RCK	
L	X	X	X	Shift register is cleared.
H	L		X	First stage of S.R. becomes "L". Other stages store the data of previous stage, respectively.
H	H		X	First stage of S.R. becomes "H". Other stages store the data of previous stage, respectively.
H	X		X	Shift register is not changed. Q8C outputs store the data of previous stage, respectively.
H	X	X		S.R. data is stored into storage register.
X	X	X		Storage register stage is not changed.

X: Don't care

**Timing Chart**



**System Diagram**



## Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	-0.5 to 7.0	V
DC input voltage	$V_{IN}$	-0.5 to 7.0	V
DC output voltage	$V_{OUT}$	-0.5 to $V_{CC} + 0.5$	V
Input diode current	$I_{IK}$	-20	mA
Output diode current	$I_{OK}$	$\pm 20$	mA
DC output current	$I_{OUT}$	$\pm 25$	mA
DC $V_{CC}$ /ground current	$I_{CC}$	$\pm 75$	mA
Power dissipation	$P_D$	180	mW
Storage temperature	$T_{stg}$	-65 to 150	$^{\circ}C$

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	2.0 to 5.5	V
Input voltage	$V_{IN}$	0 to 5.5	V
Output voltage	$V_{OUT}$	0 to $V_{CC}$	V
Operating temperature	$T_{opr}$	-40 to 85	$^{\circ}C$

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

## Electrical Characteristics

### DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40~85°C		Unit	
				V <sub>CC</sub> (V)	Min	Typ	Max	Min		Max
Positive threshold voltage	V <sub>P</sub>	—		3.0	—	—	2.20	—	2.20	V
				4.5	—	—	3.15	—	3.15	
				5.5	—	—	3.85	—	3.85	
Negative threshold voltage	V <sub>N</sub>	—		3.0	0.90	—	—	0.90	—	V
				4.5	1.35	—	—	1.35	—	
				5.5	1.65	—	—	1.65	—	
Hysteresis voltage	V <sub>H</sub>	—		3.0	0.30	—	1.20	0.30	1.20	V
				4.5	0.40	—	1.40	0.40	1.40	
				5.5	0.50	—	1.60	0.50	1.60	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	2.0	1.9	2.0	—	1.9	—	V
				3.0	2.9	3.0	—	2.9	—	
			4.5	4.4	4.5	—	4.4	—		
			I <sub>OH</sub> = -4 mA	3.0	2.58	—	—	2.48	—	
			I <sub>OH</sub> = -8 mA	4.5	3.94	—	—	3.80	—	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	2.0	—	0.0	0.1	—	0.1	V
				3.0	—	0.0	0.1	—	0.1	
				4.5	—	0.0	0.1	—	0.1	
			I <sub>OL</sub> = 4 mA	3.0	—	—	0.36	—	0.44	
			I <sub>OL</sub> = 8 mA	4.5	—	—	0.36	—	0.44	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND	0 to 5.5	—	—	±0.1	—	±1.0	μA	
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND	5.5	—	—	4.0	—	40.0	μA	

### Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40 to 85°C	Unit
			V <sub>CC</sub> (V)	Typ.	Limit	Limit	
Minimum pulse width (SCK, RCK)	$t_w$ (H)	—	3.3 ± 0.3	—	5.0	5.0	ns
	$t_w$ (L)		5.0 ± 0.5	—	5.0	5.0	
Minimum pulse width ( $\overline{\text{SCLR}}$ )	$t_w$ (L)	—	3.3 ± 0.3	—	5.0	5.0	ns
Minimum set-up time (SI-SCK)	$t_s$	—	3.3 ± 0.3	—	5.0	5.5	ns
			5.0 ± 0.5	—	3.5	3.5	
Minimum set-up time (SCK-RCK)	$t_s$	—	3.3 ± 0.3	—	8.0	8.5	ns
			5.0 ± 0.5	—	5.0	5.0	
Minimum set-up time ( $\overline{\text{SCLR}}$ -RCK)	$t_s$	—	3.3 ± 0.3	—	8.0	9.0	ns
			5.0 ± 0.5	—	5.5	6.5	
Minimum hold time (SI-SCK)	$t_h$	—	3.3 ± 0.3	—	0	0	ns
			5.0 ± 0.5	—	0	0	
Minimum hold time (SCK-RCK, $\overline{\text{SCLR}}$ -RCK)	$t_h$	—	3.3 ± 0.3	—	0	0	ns
			5.0 ± 0.5	—	0	0	
Minimum removal time ( $\overline{\text{SCLR}}$ )	$t_{rem}$	—	3.3 ± 0.3	—	5.0	6.0	ns
			5.0 ± 0.5	—	3.0	3.5	

## AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40 to 85°C		Unit		
			V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Typ.	Max		Min	Max
Propagation delay time (SCK-Q8',Q8C)	t <sub>pLH</sub>	—	3.3 ± 0.3	15	—	6.3	10.1	1.0	11.5	ns
				50	—	8.5	13.7	1.0	15.7	
	5.0 ± 0.5		15	—	4.5	6.8	1.0	7.8		
			50	—	6.3	9.3	1.0	10.6		
Propagation delay time (SCLR-Q8',Q8C')	t <sub>pHL</sub>	—	3.3 ± 0.3	15	—	10.6	16.2	1.0	18.5	ns
				50	—	12.9	19.6	1.0	22.4	
			5.0 ± 0.5	15	—	8.1	11.5	1.0	13.1	
				50	—	10.2	14.5	1.0	16.6	
Propagation delay time (RCK-Q <sub>n</sub> )	t <sub>pLH</sub>	—	3.3 ± 0.3	15	—	7.0	11.2	1.0	12.8	ns
				50	—	9.8	15.1	1.0	17.2	
	5.0 ± 0.5		15	—	5.3	8.3	1.0	9.5		
			50	—	7.7	10.9	1.0	12.4		
Maximum clock frequency	f <sub>max</sub>	—	3.3 ± 0.3	15	99	160	—	87	—	MHz
				50	73	118	—	64	—	
			5.0 ± 0.5	15	148	224	—	129	—	
				50	108	160	—	94	—	
Input capacitance	C <sub>IN</sub>	—	—	—	4	10	—	10	pF	
Power dissipation capacitance	C <sub>PD</sub>	(Note)	—	—	67	—	—	—	pF	

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

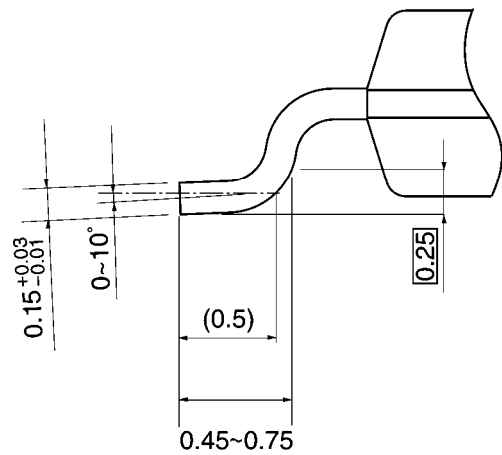
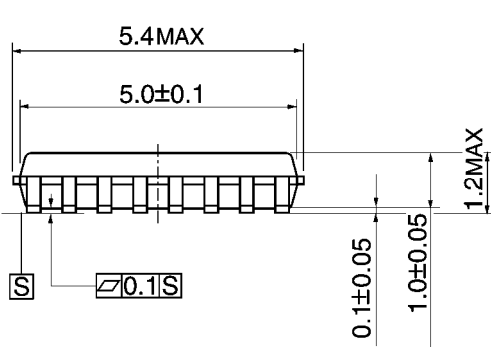
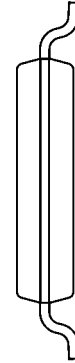
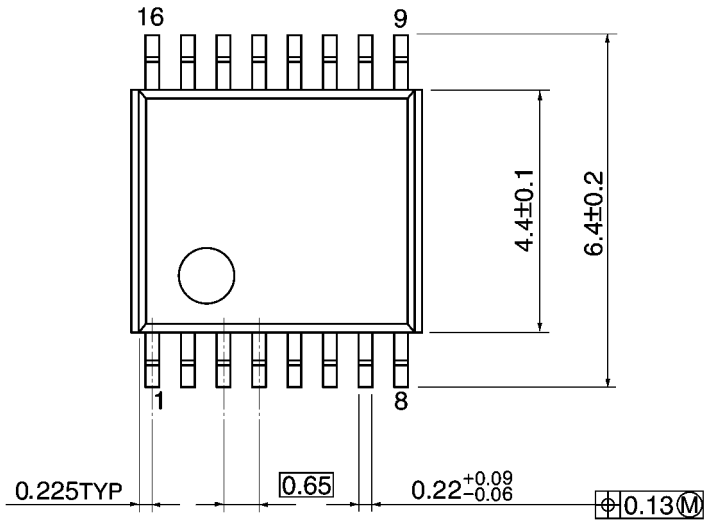
## Noise Characteristics (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol	Test Condition	Ta = 25°C			Unit
			V <sub>CC</sub> (V)	Typ.	Limit	
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	0.6	1.0	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-0.6	-1.0	V
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	—	3.5	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	—	1.5	V

**Package Dimensions**

TSSOP16-P-0044-0.65A

Unit: mm

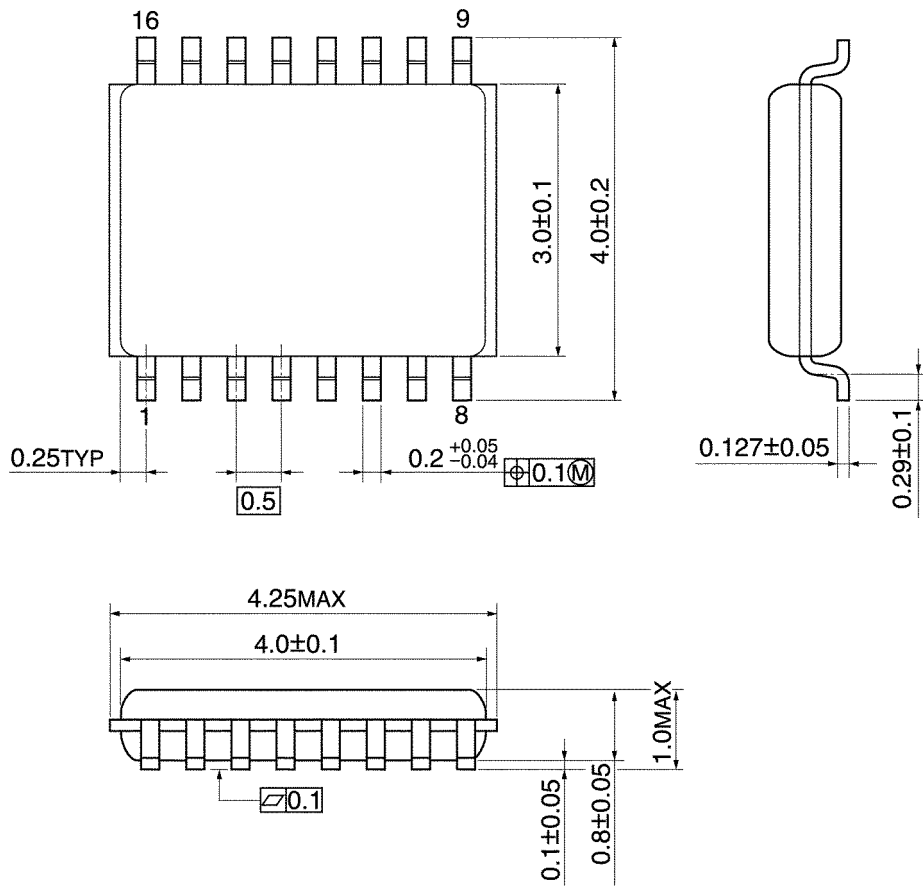


Weight: 0.06 g (typ.)

**Package Dimensions**

VSSOP16-P-0030-0.50

Unit: mm



Weight: 0.02 g (typ.)

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